

# FQB55N10 / FQI55N10 **100V N-Channel MOSFET**

## **General Description**

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

### Features

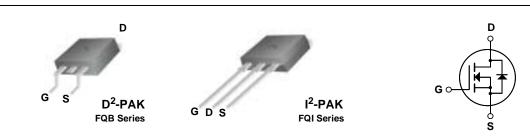
• 55A, 100V,  $R_{DS(on)} = 0.026\Omega @V_{GS} = 10 V$ • Low gate charge ( typical 75 nC)

October 2008

**QFET**<sup>®</sup>

FRE

- Low Crss (typical 130 pF) •
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating
- · RoHS Compliant



# Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted

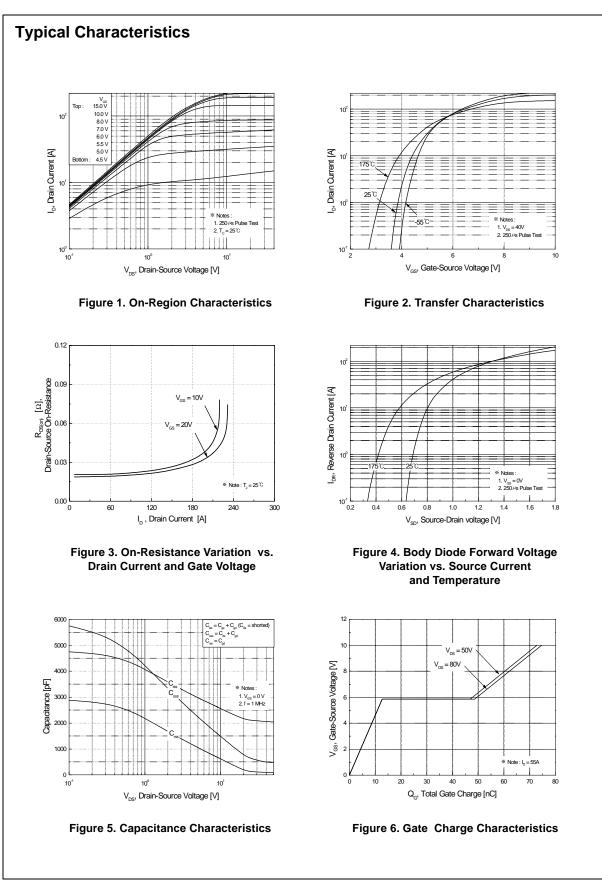
Symbol	Parameter		FQB55N10 / FQI55N10	Units
V <sub>DSS</sub>	Drain-Source Voltage		100	V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^\circ$	C)	55	А
	- Continuous (T <sub>C</sub> = 100	38.9	А	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	220	А
V <sub>GSS</sub>	Gate-Source Voltage		± 25	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	1100	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	55	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	15.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
P <sub>D</sub>	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.75	W
	Power Dissipation $(T_C = 25^{\circ}C)$		155	W
	- Derate above 25°C		1.03	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

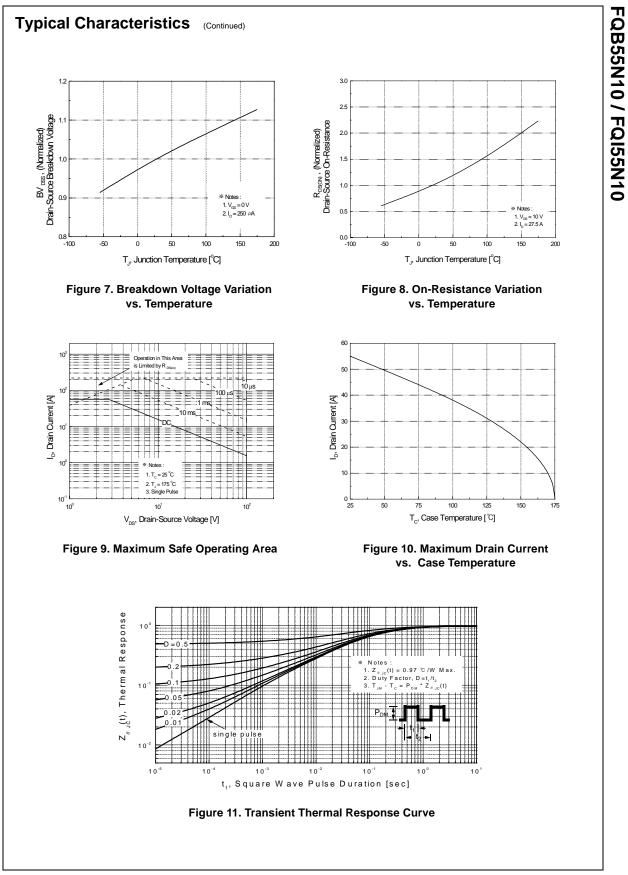
# **Thermal Characteristics**

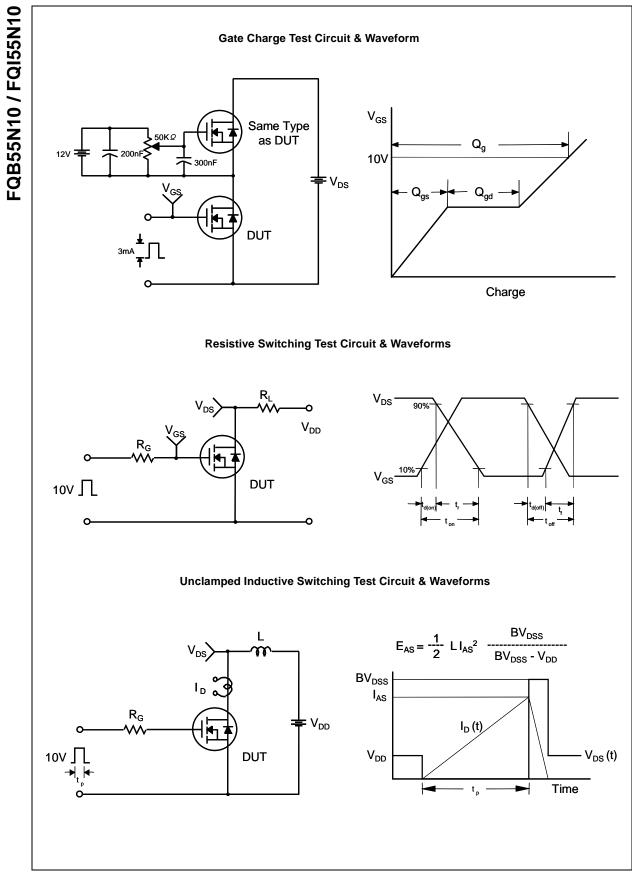
Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.97	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Parameter	Test Conditions		Min	Тур	Max	Units
racteristics						
	$V_{GS} = 0 V, I_D = 250 \mu A$		100			V
Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C			0.1		V/°C
Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V				1	μA
	V <sub>DS</sub> = 80 V, T <sub>C</sub> = 150°C				10	μA
Gate-Body Leakage Current, Forward	$V_{GS} = 25 V, V_{DS} = 0 V$				100	nA
Gate-Body Leakage Current, Reverse	$V_{GS} = -25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
ractoristics						
	Vps = Vcs. lp = 250 µA		2.0		4.0	V
Static Drain-Source	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 27.5 \text{ A}$			0.021	0.026	Ω
Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 27.5 A	(Note 4)		38		S
c Characteristics				L		I
Input Capacitance	$V_{22} = 25 V V_{22} = 0 V$			2100	2730	pF
				640	830	pF
				130	170	pF
ng Characteristics Turn-On Delay Time				25	60	ns
Turn-On Rise Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 55 \text{ A},$ $R_{G} = 25 \Omega$			250	510	ns
Turn-Off Delay Time				110	230	ns
Turn-Off Fall Time	-	(Note 4, 5)		140	290	ns
Total Gate Charge	Vpc = 80 V lp = 55 A			75	98	nC
Gate-Source Charge				13		nC
Gate-Drain Charge		(Note 4, 5)		36		nC
ource Diode Characteristics a	nd Maximum Ratings	;		L		L
Maximum Continuous Drain-Source Diode Forward Current					55	Α
	e Forward Current				220	Α
Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 55 A$				1.5	V
	$V_{GS} = 0 V, I_{S} = 55 A,$			100		ns
Reverse Recovery Time		(Note 4)		380		nC
	Coefficient Zero Gate Voltage Drain Current Gate-Body Leakage Current, Forward Gate-Body Leakage Current, Reverse racteristics Gate Threshold Voltage Static Drain-Source On-Resistance Forward Transconductance C Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance ng Characteristics Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Ource Diode Characteristics an Maximum Continuous Drain-Source Dio	Drain-Source Breakdown Voltage $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ Breakdown Voltage Temperature Coefficient $I_D = 250 \mu\text{A}$ , Referenced 1Zero Gate Voltage Drain Current $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ Gate-Body Leakage Current, Forward $V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$ Gate-Body Leakage Current, Reverse $V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$ Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ Static Drain-Source On-Resistance $V_{DS} = 10 \text{ V}, I_D = 27.5 \text{ A}$ Forward Transconductance $V_{DS} = 40 \text{ V}, I_D = 27.5 \text{ A}$ Input Capacitance Reverse Transfer Capacitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 27.5 \text{ A}$ Turn-On Delay Time Turn-On Delay Time $V_{DD} = 50 \text{ V}, I_D = 55 \text{ A}, R_G = 25 \Omega$ Turn-Off Delay Time Turn-Off Fall Time $V_{DS} = 80 \text{ V}, I_D = 55 \text{ A}, V_{GS} = 10 \text{ V}$ Total Gate Charge Gate-Drain Charge $V_{DS} = 80 \text{ V}, I_D = 55 \text{ A}, V_{GS} = 10 \text{ V}$ Output Capacitance $V_{DS} = 10 \text{ V}$ Turn-Off Delay Time Turn-Off Fall Time $V_{DS} = 80 \text{ V}, I_D = 55 \text{ A}, V_{GS} = 10 \text{ V}$ Total Gate Charge Gate-Drain Charge $V_{DS} = 10 \text{ V}$ Durce Diode Characteristics and Maximum Ratings	Drain-Source Breakdown Voltage $V_{GS} = 0 \text{ V}, I_D = 250 \ \mu\text{A}$ Breakdown Voltage Temperature Coefficient $I_D = 250 \ \mu\text{A}$ , Referenced to $25^\circ\text{C}$ Zero Gate Voltage Drain Current $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ Gate-Body Leakage Current, Forward $V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$ Gate-Body Leakage Current, Reverse $V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$ Gate-Body Leakage Current, Reverse $V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$ Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu\text{A}$ Static Drain-Source On-Resistance $V_{GS} = 10 \text{ V}, I_D = 27.5 \text{ A}$ Forward Transconductance $V_{DS} = 40 \text{ V}, I_D = 27.5 \text{ A}$ Input Capacitance Output Capacitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DS} = 25 \text{ O}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz $V_{DD} = 50 \text{ V}, I_D = 55 \text{ A},$ f = 1.0 MHz $V_{DS} = 80 \text{ V}, I_D = 55 \text{ A},$ f = 10 Glay Time Turn-Off Belay Time $V_{DS} = 80 \text{ V}, I_D = 55 \text{ A},$ f = 10 Gate Charge Gate-Drain Charge $V_{DS} = 10 \text{ V}$ f = 10 V(Note 4, 5)Output CharacteristicsMaximum Continuous Drain-Source Diode Forward Current	$\begin{array}{c c c c c c } \mbox{Drain-Source Breakdown Voltage} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 100 \\ \hline \mbox{Breakdown Voltage Temperature} & I_D = 250 \ \mu A, \ Referenced to 25°C & \\ \hline \mbox{Deficient} & I_D = 250 \ \mu A, \ Referenced to 25°C & \\ \hline \mbox{VDS} = 80 \ V, \ V_{GS} = 0 \ V & \\ \hline \mbox{VDS} = 80 \ V, \ T_C = 150°C & \\ \hline \mbox{Gate-Body Leakage Current, Forward} & V_{GS} = 25 \ V, \ V_{DS} = 0 \ V & \\ \hline \mbox{Gate-Body Leakage Current, Reverse} & V_{GS} = -25 \ V, \ V_{DS} = 0 \ V & \\ \hline \mbox{Gate-Body Leakage Current, Reverse} & V_{GS} = -250 \ \mu A & 2.0 \\ \hline \mbox{Static Drain-Source} & V_{DS} = 10 \ V, \ I_D = 27.5 \ A & \\ \hline \mbox{On-Resistance} & V_{DS} = 40 \ V, \ I_D = 27.5 \ A & (Note 4) & \\ \hline \mbox{Characteristics} & \\ \hline \mbox{Input Capacitance} & V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, & \\ \hline \mbox{Characteristics} & \\ \hline \mbox{Input Capacitance} & V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, & \\ \hline \mbox{Characteristics} & \\ \hline \mbox{Input Capacitance} & V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, & \\ \hline \mbox{Input Capacitance} & V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, & \\ \hline \mbox{Input Capacitance} & V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, & \\ \hline \mbox{Input Capacitance} & V_{DD} = 50 \ V, \ I_D = 55 \ A, & \\ \hline \mbox{Input Of Belay Time} & (Note 4, 5) & \\ \hline \mbox{Input Off Fall Time} & (Note 4, 5) & \\ \hline \mbox{Input Off Fall Time} & (Note 4, 5) & \\ \hline \mbox{Input Off Fall Time} & (Note 4, 5) & \\ \hline \mbox{Input Oracle Characteristics and Maximum Ratings} \\ \hline \mbox{Maximum Continuous Drain-Source Diode Forward Current} & \\ \hline \mbox{Input On Nous Drain-Source Diode Forward Current} & \\ \hline \mbox{Input On Nous 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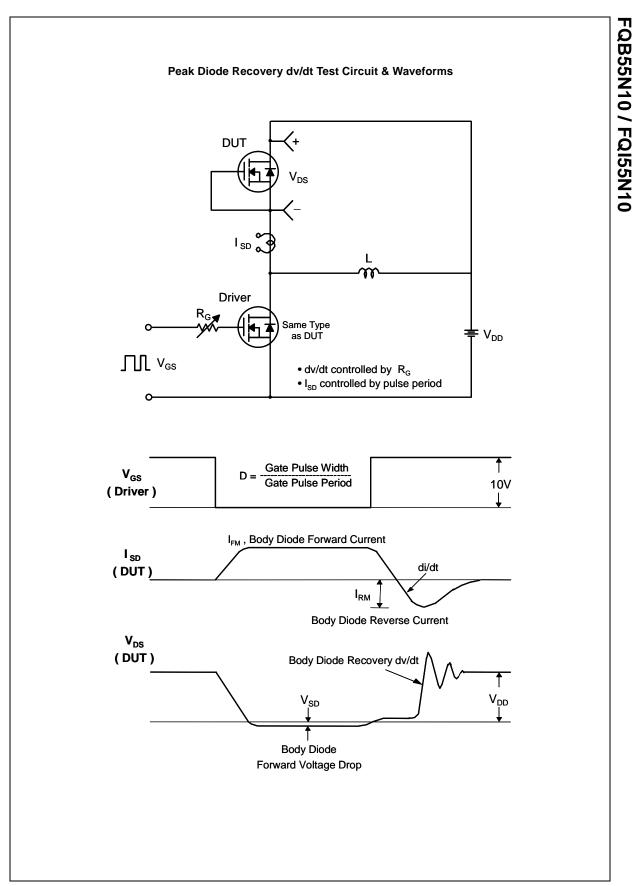






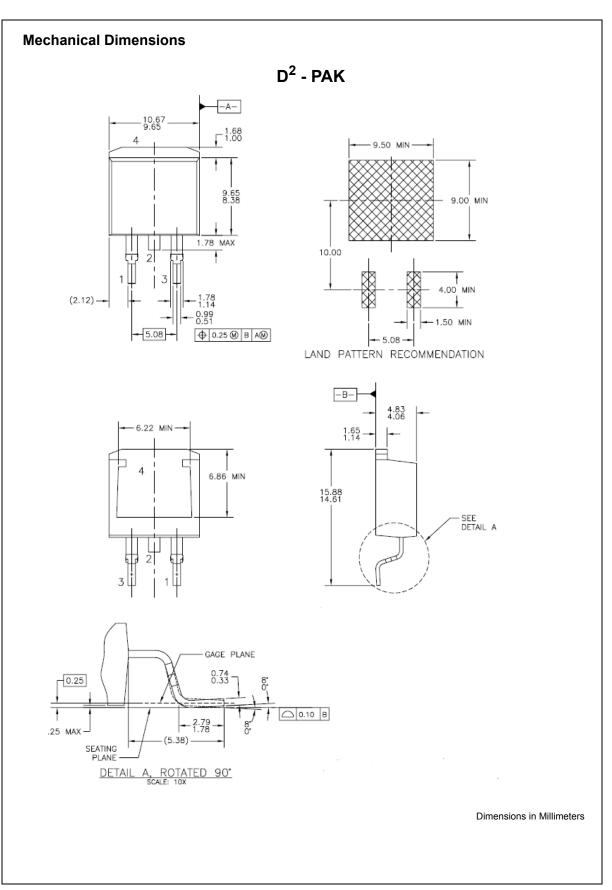


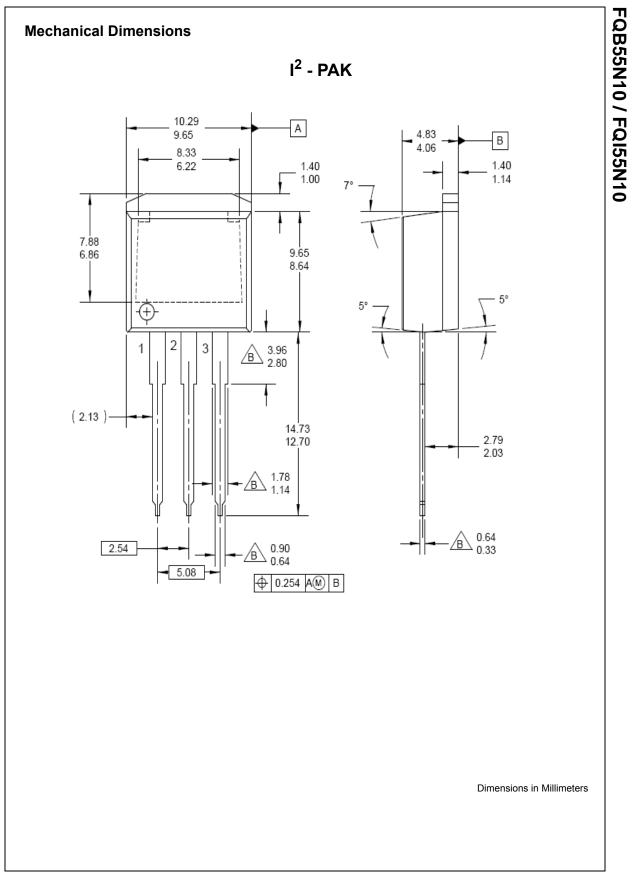
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